

PATENT
10/590,683

PATENT COOPERATION TREATY

Applicants : Shigeki Satou et al.
Int'l Application No. : PCT/JP2005/002882
Int'l Filing Date : February 23, 2005
Title : CONDUCTIVE PASTE FOR A MULTI-LAYERED
CERAMIC ELECTRONIC COMPONENT AND A
METHOD FOR MANUFACTURING A MULTI-
LAYERED UNIT FOR A MULTI-LAYERED
CERAMIC ELECTRONIC COMPONENT

Docket No. : 890050.545USPC
Date : August 25, 2006

Mail Stop PCT
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT TRANSMITTAL

Commissioner for Patents:

In accordance with 37 CFR 1.56 and 1.97 through 1.98, applicants wish to make known to the U.S. Patent and Trademark Office the references set forth on the attached Information Disclosure Statement. Copies of cited U.S. patents and published patent applications are not required and accordingly have not been provided. Copies of any other cited references are enclosed. As to any reference cited, applicants do not admit that it is "prior art" under 35 U.S.C. §§ 102 or 103, and specifically reserve the right to traverse or antedate any such reference, as by a showing under 37 CFR 1.131 or other method. Although the aforesaid references are made known to the Patent and Trademark Office in compliance with applicants' duty to disclose all information they are aware of which is believed relevant to the examination of the above-identified application, applicants believe that their invention is patentable.

Please acknowledge receipt of this Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

IAP5 Rec'd PCT/PTO 25 AUG 2006

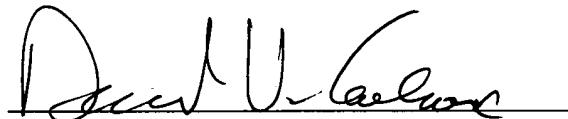
10/590683

Applicants attorney states that a co-pending case filed today bearing the title "CONDUCTIVE PASTE FOR A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT AND A METHOD FOR MANUFACTURING A MULTI-LAYERED UNIT FOR A MULTI-LAYERED CERAMIC ELECTRONIC COMPONENT", PCT application number PCT/JP2005/002881 and an International Filing Date of February 23, 2005. These two applications are in the same general technology areas and we wish to provide this information to the Examiner.

Applicants believe this Information Disclosure Statement has been timely filed, however, the Director is authorized to charge any fee due by way of this Information Disclosure Statement to our Deposit Account No. 19-1090.

Respectfully submitted,

Seed Intellectual Property Law Group PLLC



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Enclosures:

Information Disclosure Statement
Cited References (12)

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U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			ATTY. DOCKET NO. 890050.545USPC	APPLICATION NO. 10/590683
INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)			APPLICANTS Shigeki Satou et al.	
			FILING DATE February 23, 2005	GROUP ART UNIT

U.S. PATENT DOCUMENTS

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						

FOREIGN PATENT DOCUMENTS

		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES NO
	AF	05-325633	12/10/93	JP (+ Abstract in English)	
	AG	06-053654	02/25/94	JP (+ Abstract in English)	
	AH	06-085466	03/25/94	JP (+Abstract in English)	
	AI	06-224556	08/12/94	JP (+Abstract in English)	
	AJ	07-021832	01/24/95	JP (+Abstract in English)	
	AK	07-021833	01/24/95	JP (+Abstract in English)	
	AL	10-275734	10/13/98	JP (+Abstract in English)	
	AM	11-053939	02/26/99	JP (+Abstract in English)	
	AN	11-273987	10/08/99	JP (+Abstract in English)	
	AO	2002-270456	09/20/02	JP (+Abstract in English)	
	AP	2003-017356	01/17/03	JP (+Abstract in English)	
	AQ	2003-249121	09/05/03	JP (+Abstract in English)	

OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)

AR		
AS		

EXAMINER	DATE CONSIDERED
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* EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).